

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

I hereby certify that this paper is being Applicant: Sung Gyu Pyo deposited with the United States Postal Service as first class mail, Serial No.: 09/875,698 postage prepaid, in an envelope addressed to: Commissioner for Filed: June 6, 2001 Patents Washington, DC 20231 on For: Method of Forming a Metal March 27, 2003 Wiring in a Semiconductor Device Group Art Unit: 1765 Reg. No. 35,902 Examiner: Lynette T. Umex Attorney for Applicant

INFORMATION DISCLOSURE STATEMENT AFTER FIRST OFFICE ACTION

Commissioner for Patents Washington, DC 20231

Sir:

The patents listed on the enclosed PTO/SB/08 are submitted pursuant to 37 C.F.R. §§ 1.56, 1.97 and 1.98. Copies of the patents are enclosed as necessary.

This information disclosure statement is being filed after the mailing date of a first office action, but to the best of the undersigned's knowledge, before the mailing date of a final action under 37 C.F.R. § 1.113 or notice of allowance under 37 C.F.R. § 1.311.

Enclosed is a copy of a communication from the Korean Intellectual Property Office dated March 11, 2003.

Applicants submit herewith a certification as specified in 37 C.F.R. § 1.97(e) and a check in the amount of \$180.00 for the Information Disclosure Statement processing fee as specified in 37 C.F.R. § 1.17(p).

The person signing below certifies that each item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office not more than three months prior to the filing of this statement (37 C.F.R. § 1.97(e)(1)).

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The Commissioner is authorized to charge any deficiency required by this paper, or credit any overpayment, to Deposit Account No. 13-2855.

Respectfully submitted,

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March 27, 2003

By:

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